



### 30V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
-30V	$20m\Omega$ @ $V_{GS} = -10V$	-30A
-307	$29m\Omega @ V_{GS} = -5V$	-30A

### **Features and Benefits**

- Low R<sub>DS(ON)</sub> ensures on state losses are minimized.
- Small form factor thermally efficient package enables higher density end products.
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product.
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

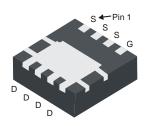
- Backlighting
- Power Management Functions
- DC-DC Converters

#### **Mechanical Data**

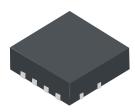
- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
   Terminals: Finish Matte Tin Annealed over Copper Leadframe.

   Solderable per MIL-STD-202, Method 208(§3)
- Weight: 0.03 grams (Approximate)

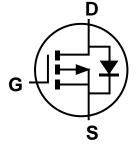
#### PowerDI3333-8



**Bottom View** 



Top View



**Equivalent Circuit** 

### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMP3036SFG-7	PowerDI3333-8	2,000/Tape & Reel
DMP3036SFG-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at httphttps://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

PowerDI3333-8

MMAA P36

P36 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	-30	V	
Gate-Source Voltage	$V_{GSS}$	±25	V	
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-8.7 -7.0	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = -10V	$T_C = +25$ °C $T_C = +70$ °C	I <sub>D</sub>	-30 -25	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -5V	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-7.2 -5.8	А
Continuous Drain Current (Note 7) $V_{GS} = -5V$ $T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$		I <sub>D</sub>	-30 -24	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-80	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	-3.6	Α	
Avalanche Current (Note 7) L=0.3mH		I <sub>AS</sub>	-17.5	Α
Avalanche Energy (Note 7) L=0.3mH	Eas	64	mJ	

# Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_{D}$	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	6	137	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	65	°C/W
Total Power Dissipation (Note 6)		$P_{D}$	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	ב	55	°C/W
Thermal Resistance, Junction to Ambient (Note o)	t<10s	$R_{\theta JA}$	26	°C/W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	3.5	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	-1.0	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	-2.0	-2.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		1	13	20	m0	$V_{GS} = -10V, I_D = -8A$	
Static Dialii-Source Off-Resistance	R <sub>DS(ON)</sub>	-	18.4	29	mΩ	$V_{GS} = -5V, I_{D} = -5A$	
Diode Forward Voltage	$V_{SD}$	-	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	-	1931	-	pF	\	
Output Capacitance	Coss	ı	226	-	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	168	-	рF	1 = 1:0\vii 12	
Gate Resistance	$R_g$	-	10.9	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge V <sub>GS</sub> = -5V	$Q_g$	-	8.8	-	nC		
Total Gate Charge V <sub>GS</sub> = -10V	$Q_g$	-	16.5	-	nC	\/ 45\/ L 40A	
Gate-Source Charge	Q <sub>gs</sub>	-	2.6	-	nC	$V_{DS} = -15V, I_{D} = -10A$	
Gate-Drain Charge	$Q_{gd}$	-	3.6	-	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	-	8.2	-	ns		
Turn-On Rise Time	t <sub>R</sub>		14	-	ns	$V_{GS} = -10V, V_{DD} = -15V,$ $R_{GEN} = 3\Omega, I_{D} = -10A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	65	-	ns		
Turn-Off Fall Time	t <sub>F</sub>	•	31.6	-	ns		
Reverse Recovery Time	t <sub>RR</sub>	•	9.3	-	ns		
Reverse Recovery Charge	$Q_{RR}$	ı	12.2	-	nC I <sub>F</sub> = -8A, di/dt = 500A/µs		

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

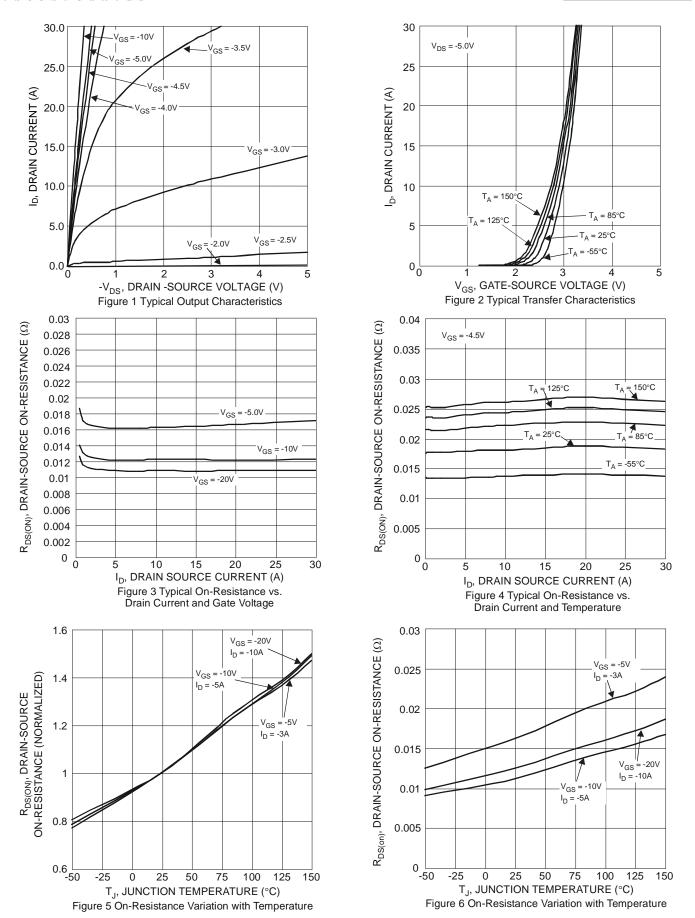
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.

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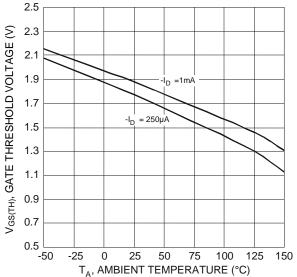


Figure 7 Gate Threshold Variation vs. Ambient Temperature

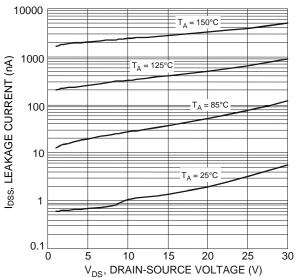
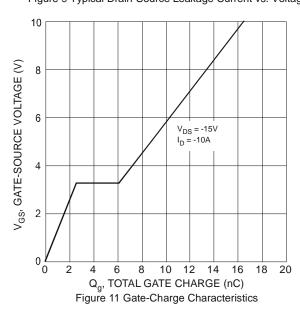
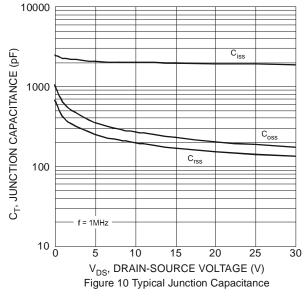
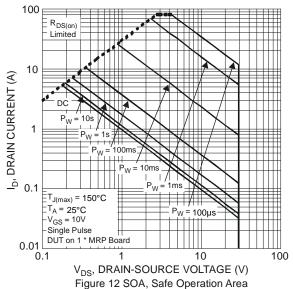


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

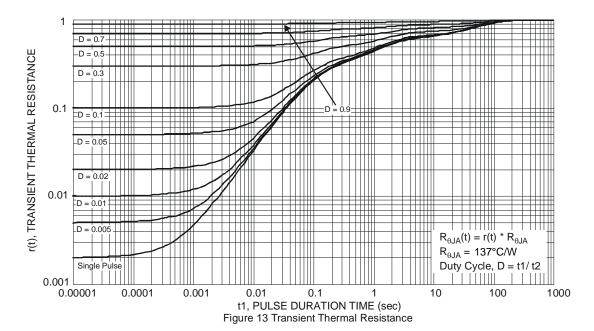


30 25 (Y) 20 20 10 T<sub>A</sub>= 150°C T<sub>A</sub>= 25°C T<sub>A</sub>= 95°C T<sub>A</sub>= 95°C









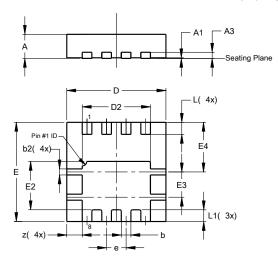
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## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8

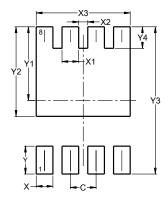


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	_	_	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8



Dimensions	value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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